

**GLASS PASSIVATED BRIDGE RECTIFIERS**

REVERSE VOLTAGE - **50 to 1000** Volts  
FORWARD CURRENT - **8.0** Amperes

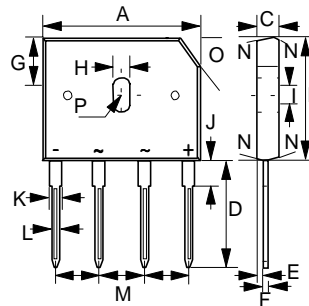
**FEATURES**

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- The plastic material has UL flammability classification 94V-0
- UL Recognition File # E95060

**MECHANICAL DATA**

- Polarity : Symbols molded on body
- Weight : 0.15 ounces, 4.0 grams
- Mounting position : Any

**GBU**



GBU		
DIM.	MIN.	MAX.
A	21.80	22.30
B	18.30	18.80
C	3.30	3.56
D	17.50	18.00
E	0.76	1.00
F	0.46	0.56
G	7.40	7.90
H	3.50	4.10
I	1.65	2.16
J	2.25	2.75
K	1.95	2.35
L	1.02	1.27
M	4.83	5.33
N	7.0° TYPICAL	
O	3.2 x 45°	
P	1.90 RADIUS	

All Dimensions in millimeter

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.  
Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBU 8005	GBU 801	GBU 802	GBU 804	GBU 806	GBU 808	GBU 810	UNIT	
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current @Tc=100°C (with heatsink Note 2) Rectified Current @Tc=100°C (without heatsink)	I(AV)					8.0				A
						3.2				
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	IFSM					200				A
Maximum forward Voltage at 4.0A DC	VF					1.0				V
Maximum DC Reverse Current at Rated DC Blocking Voltage	IR					5.0				uA
						500				
I <sup>2</sup> t Rating for fusing (t < 8.3ms)	I <sup>2</sup> t					166				A <sup>2</sup> S
Typical Junction Capacitance per element (Note 1)	CJ					60				pF
Typical Thermal Resistance (Note 2)	RθJC					2.2				°C/W
Operating Temperature Range	TJ					-55 to +150				°C
Storage Temperature Range	TSTG					-55 to +150				°C

NOTES : 1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
2.Device mounted on 100mm x 100mm x 1.6mm Cu Plate Heatsink.

REV. 2, 01-Dec-2000, KBDJ03

